



Parameter	Rating	Units
Blocking Voltage	600	V <sub>P</sub>
Load Current	90	mA <sub>rms</sub> / mA <sub>DC</sub>
On-Resistance (Max)		
I <sub>L</sub> =120mA (t <u>&lt;</u> 1s)	35	0
I <sub>L</sub> =90mA	40	52

#### **Features**

- 5000V<sub>rms</sub> Input/Output Isolation
   600V<sub>P</sub> Blocking Voltage
- 100% Solid State
- Low Drive Power Requirements
- · Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 4-Pin Package

#### **Applications**

- · Meters (Watt-Hour, Water, Gas)
- Industrial Controls
- Instrumentation
- Data Acquisition
- · Medical Equipment—Patient/Equipment Isolation
- · Electronic Switching
- I/O Subsystems
- Multiplexers
- Security

### **Description**

The CPC1394 is a single-pole, normally-open (1-Form-A) Solid State Relay with an enhanced input to output isolation barrier of 5000V<sub>rms</sub>.

The relay output is constructed with efficient MOSFET switches that use IXYS Integrated Circuits Division's patented OptoMOS architecture. The input, a highly efficient infrared LED, controls the optically coupled output.

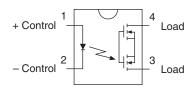
## **Approvals**

- UL Certified Component: File E76270
- EN/IEC 60950-1: Certificate # B 082667 0007

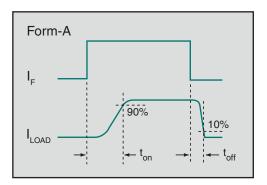
## **Ordering Information**

Part Number	Description		
CPC1394G	4-Pin DIP (100/Tube)		
CPC1394GV	4-Pin DIP V-Bend (100/Tube)		
CPC1394GR	4-Pin Surface Mount (100/Tube)		
CPC1394GRTR	4-Pin Surface Mount (1000/Reel)		

# **Pin Configuration**



**Switching Characteristics** of Normally Open Devices











# Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Peak Blocking Voltage	600	$V_P$
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	Α
Input Power Dissipation <sup>1</sup>	100	mW
Total Package Dissipation <sup>2</sup>	550	mW
Isolation Voltage, Input to Output	5000	V <sub>rms</sub>
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

<sup>&</sup>lt;sup>1</sup> Derate linearly 1.33mW / °C

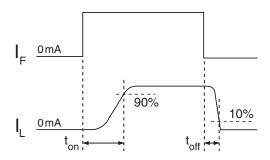
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

### **Electrical Characteristics @ 25°C**

Conditions	Symbol	Min	Тур	Max	Units	
-	IL	-	-	90	$mA_{rms} / mA_{DC}$	
t=10ms	I <sub>LPK</sub>	-	-	±600	mA <sub>P</sub>	
I <sub>L</sub> =90mA	D		30	40	Ω	
I <sub>L</sub> =120mA, t <u>&lt;</u> 1s	n <sub>ON</sub>		26	35	52	
V <sub>L</sub> =600V <sub>P</sub>	I <sub>LEAK</sub>	-	-	1	μΑ	
$I_F=5mA, V_L=10V$	t <sub>on</sub>	-	0.85	5		
(See Timing Diagram)	t <sub>off</sub>	-	0.46	3	- ms	
I <sub>F</sub> =0mA, V <sub>L</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	50	-	pF	
<u>.</u>			•	•		
I <sub>L</sub> =120mA	I <sub>F</sub>	-	0.45	2	mA	
-	I <sub>F</sub>	0.2	0.4	-		
I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.36	1.5	V	
V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μΑ	
<u>'</u>					•	
V <sub>IO</sub> =0V, f=1MHz	C <sub>IO</sub>	-	3	-	pF	
	$I_{L}=90\text{mA}$ $I_{L}=120\text{mA}, \text{t} \leq 1\text{s}$ $V_{L}=600\text{V}_{P}$ $I_{F}=5\text{mA}, \text{V}_{L}=10\text{V}$ (See Timing Diagram) $I_{F}=0\text{mA}, \text{V}_{L}=50\text{V}, \text{f}=1\text{MHz}$ $I_{L}=120\text{mA}$ $I_{F}=5\text{mA}$ $V_{R}=5\text{V}$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	

# **Timing Diagram**

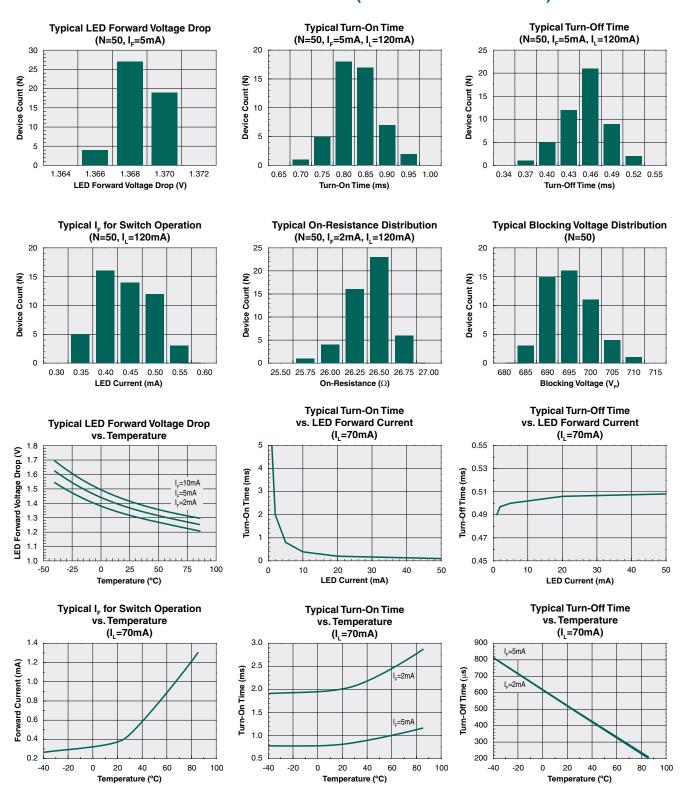


<sup>&</sup>lt;sup>2</sup> Derate output linearly 5.4mW / °C

Derate linearly 0.58mA / °C
 Measurement taken within 1 second of on-time.
 For operation at temperatures >60°C, a minimum LED drive current of 4mA is recommended.



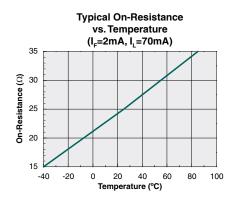
# PERFORMANCE DATA @25°C (Unless Otherwise Noted)\*

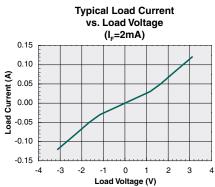


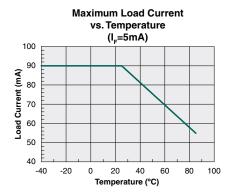
\*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.

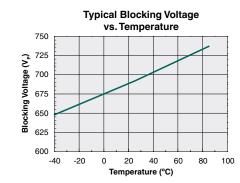


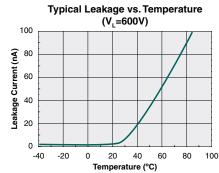
# PERFORMANCE DATA @25°C (Unless Otherwise Noted)\*

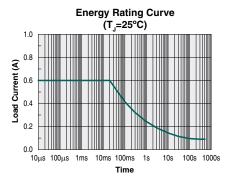














### **Manufacturing Information**

#### **Moisture Sensitivity**



All plastic encapsulated semiconductor packages are susceptible to moisture ingression, IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard IPC/JEDEC J-STD-033.

Device	Moisture Sensitivity Level (MSL) Classification
CPC1394GR	MSL 3

#### **ESD Sensitivity**



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

#### **Soldering Profile**

Provided in the table below is the IPC/JEDEC J-STD-020 Classification Temperature ( $T_{\rm C}$ ) and the maximum dwell time the body temperature of these surface mount devices may be (T<sub>C</sub> - 5)°C or greater. The Classification Temperature sets the Maximum Body Temperature allowed for these devices during reflow soldering processes.

Device	Classification Temperature (T <sub>c</sub> )	Dwell Time (t <sub>p</sub> )	Max Reflow Cycles
CPC1394GR	250°C	30 seconds	3

For through-hole devices, the wave soldering maximum lead (pin) temperature and the maximum dwell time the leads (pins) are at the peak soldering temperature is given in the table below. Maximum wave soldering parameters are shown below.

Device	Pin Temperature	<b>Body Temperature</b>	Dwell Time	Wave Cycles
CPC1394G / CPC1394GV	260°C	250°C	10 seconds	1

#### **Board Wash**

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to halide flux or solvents.



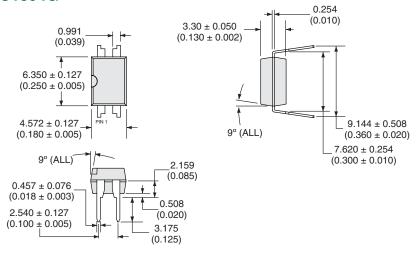




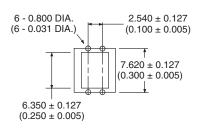


#### **MECHANICAL DIMENSIONS**

#### **CPC1394G**

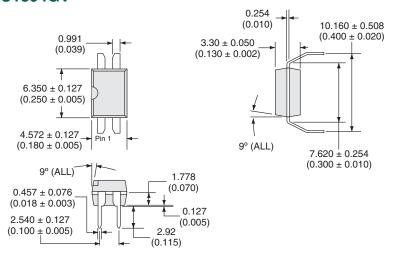


#### PC Board Pattern (Top View)

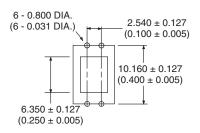


Dimensions mm (inches)

#### **CPC1394GV**



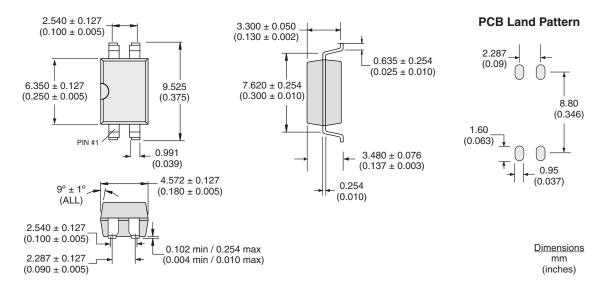
#### PC Board Pattern (Top View)



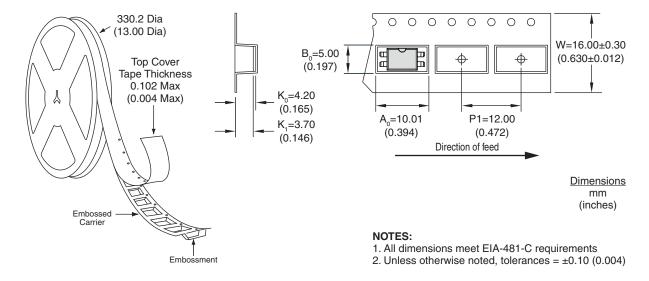
Dimensions mm (inches)



#### **CPC1394GR**



### **CPC1394GRTR Tape & Reel**



#### For additional information please visit our website at: www.ixysic.com



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